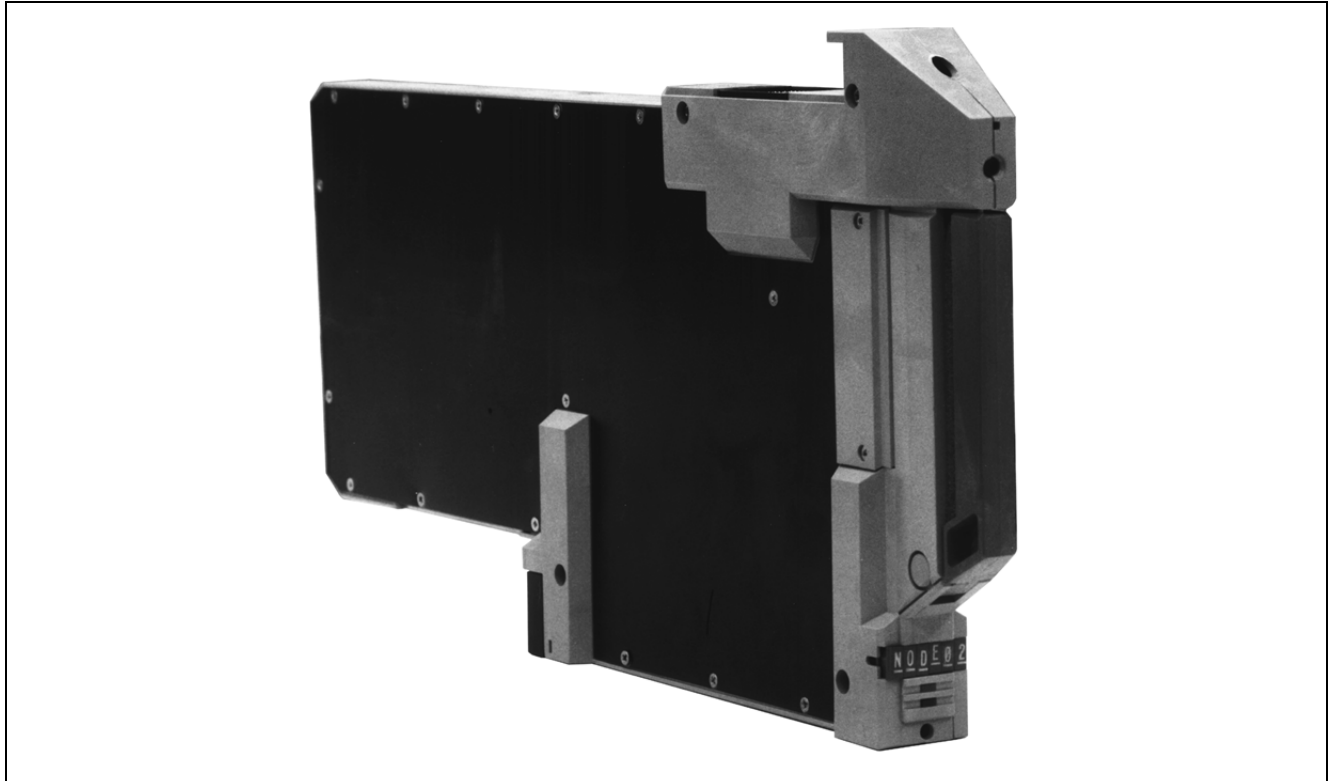


## **I/A Series® Hardware MicroPack Control Processor**



The MicroPack Control Processor performs regulatory, logic, timing, and sequential control, in combination with:

- Fieldbus Modules (FBMs)
- Fieldbus Cluster I/O Cards (FBCs)
- SPECTRUM Migration Integrator I/O
- SPEC 200 Migration Integrator I/O
- SPEC 200 MICRO Migration Integrator I/O
- Honeywell Migration Integrator I/O
- Fisher PROVOX Migration Integrator I/O
- Bailey Migration Integrator I/O.

It also performs data acquisition and alarm detection and notification, and may optionally serve as an interface for one or more Panel Display Stations.

The non-fault-tolerant version of the MicroPack Control Processor is a single-width processor module. The fault-tolerant version consists of two single-width processor modules.

### Enhanced Reliability

The MicroPack Control Processor offers optional fault-tolerance for enhanced reliability. The fault-tolerant Control Processor configuration consists of two modules operating in parallel with two separate connections to the Nodebus and to the Fieldbus.

The two Control Processor (CPs), married together as a fault-tolerant pair, are designed to provide continued operation of the unit in the event of virtually any hardware failure occurring within one of the pair. Both modules receive and process information simultaneously, and faults are detected by the modules themselves. One of the significant methods of fault detection is comparison of communication messages at the module external interfaces. Upon detection of a fault, self-diagnostics are run by both modules to determine which module is defective. The non-defective module then assumes control without affecting normal system operations.

To further ensure reliable communications, the fault-tolerant Control Processor performs error detection and address verification tests in its Nodebus and Fieldbus interfaces.

For enhanced reliability during maintenance operations, the MicroPack Control Processor is equipped with a recessed reset button, located at the front of the module. This feature allows you to manually force a module's power off and on (reboot) without removing the module from the enclosure.

### Diagnostics

The MicroPack Control Processor uses three types of diagnostic tests to detect and isolate faults:

- Power-up self-checks
- Run-time and watchdog timer checks
- Off-line diagnostics.

Power-up self-checks are self-initiated when power is applied to the Control Processor. These checks perform sequential tests on the various Control Processor functional elements. Red and green indicators at the front of the Control Processor module reflect the successful (or unsuccessful) completion of the various phases of the Control Processor startup sequence.

The run-time and watchdog timer checks provide continuous monitoring of Control Processor functions during normal system operations. The operator is informed of a malfunction by means of printed or displayed system messages.

Off-line diagnostics are temporarily loaded into the system for the purpose of performing comprehensive tests and checks on various system stations and devices. Using the off-line diagnostics, you can isolate and confirm a suspected fault in the Control Processor.

### Fieldbus Modules

Fieldbus Modules connect digital I/O, analog I/O, and Intelligent Transmitters to Control Processors. There are two types of Fieldbus Modules: main and expansion. Some main modules can be expanded using expansion modules.

A wide range of Fieldbus Modules is available to perform the signal conversion necessary to interface the Control Processor with field sensors and actuators. For further information on the Fieldbus Modules, refer to the Fieldbus Modules Product Specification Sheet (PSS).

### Fieldbus Flexibility

The MicroPack Control Processor is used in three different Fieldbus configurations, which provide broad flexibility in Fieldbus implementation:

- Local Fieldbus (Figure 1) - Used only within the enclosure, the local bus can extend up to 10 m (30 ft). Up to 24 Fieldbus Modules (excluding expansion modules) attach directly to the local bus, which is redundant.

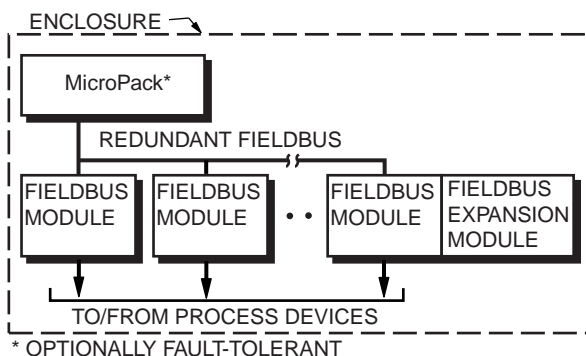


Figure 1. Local Fieldbus (Typical Configuration)

- Twinaxial (Dual-Conductor Coaxial) Fieldbus Extension (Figure 2) - Using a twinaxial cable, the Fieldbus can optionally extend outside of the enclosure and can be up to 1800 m (6,000 ft) in length. Up to 64 Fieldbus Modules (excluding expansion modules) attach to the extended bus through Fieldbus Isolators. Up to 24 Fieldbus Modules, excluding expansion modules, can connect to each isolator. The twinaxial Fieldbus extension may be redundant.
- Fiber Optic Fieldbus Extension (Figure 3) - The fiber optic Fieldbus can optionally extend the distance as well as add application versatility and security. Overall Fieldbus length can be up to 20 km (12.4 mi). Like the twinaxial Fieldbus configuration, the fiber optic Fieldbus configuration supports up to 64 Fieldbus Modules (excluding expansion modules), and up to 24 modules per isolator.

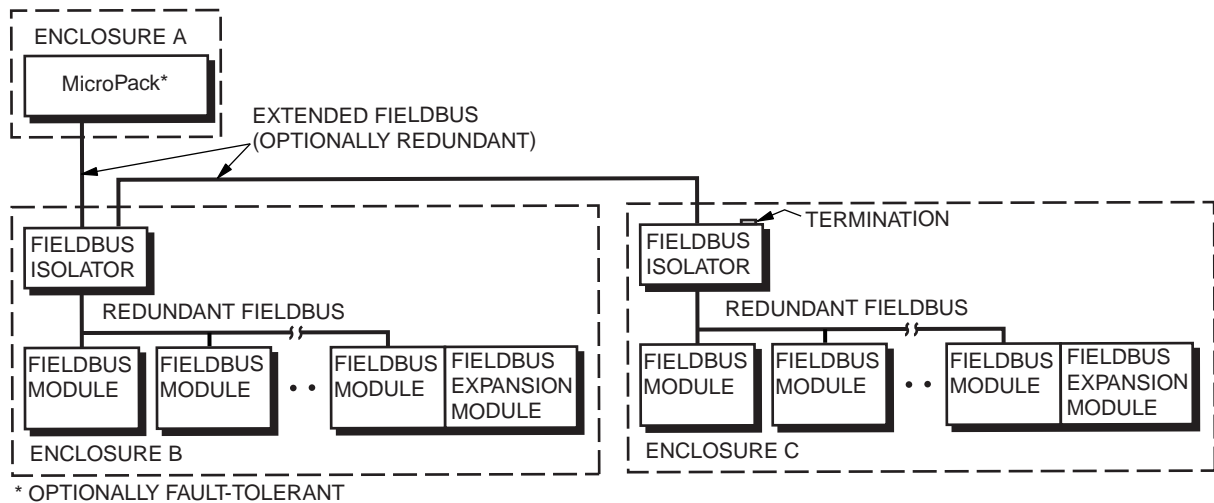
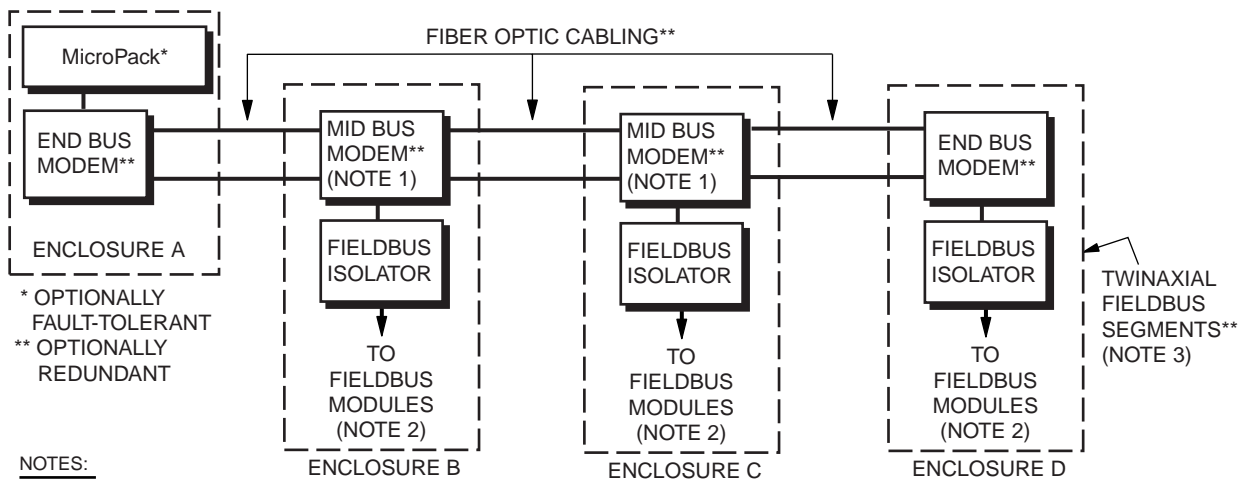


Figure 2. Twinaxial Fieldbus Extension (Typical Configuration)



1. THE MID BUS MODEMS ARE USED WHEN THE CONFIGURATION ENCOMPASSES MORE THAN TWO ENCLOSURES. THEY MAY ALSO BE USED AS REPEATERS, WHERE ADDED FIBER OPTIC CABLING DISTANCE IS REQUIRED.
2. CONNECTION OF THE FIBER ISOLATORS TO THE FIELDBUS MODULES (FBMs) IS SIMILAR TO THAT SHOWN IN FIGURE 2.
3. ANY TWINAXIAL FIELDBUS SEGMENT CAN BE EXTENDED TO SERVICE FBMs IN ANOTHER ENCLOSURE. (TWINAXIAL CABLING BETWEEN ENCLOSURES IS SHOWN IN FIGURE 2.)

Figure 3. Fiber Optic Fieldbus Extension (Typical Configuration)

All three Fieldbus configurations use serial data communication complying with Electronic Industrial Association (EIA) Standard RS-485. The data transmission rate is 268.75 Kbps.

**Panel Display Station Interfacing**

The MicroPack Control Processor achieves the capability to interface with Panel Display Stations when the Display Station Interface (DSI) block is selected via the configurator. In this capacity the MicroPack Control Processor can interface with up to 24 Panel Display Stations, or a combination of Fieldbus Modules (which may include associated Auto/Manual Stations) and Panel Display Stations mixed on the same Fieldbus. Note, however, that per configuration rules, one Panel Display Station counts as two Fieldbus Modules.

Control strategy should be planned such that all blocks involved with the Panel Display Station, Auto/Manual Station, and the control loops being monitored or controlled are in the same MicroPack Control Processor, and ideally in the same compound.

The MicroPack Control Processor connects to the Panel Display Stations and Fieldbus Modules via either of two types of Fieldbus communications media: twinaxial cable or fiber optic cable. Figure 4 shows a typical twinaxial Fieldbus configuration, and Figure 5 shows a typical fiber optic Fieldbus configuration. Refer to Fiber Optic Fieldbus Product Specification Sheet for additional fiber optic Fieldbus application information.

**Cluster I/O Subsystem Interfacing**

The MicroPack Control Processor interfaces with the Fieldbus Cluster Input/Output subsystem that consists of the Fieldbus, a multi-slot chassis configuration of a Fieldbus Processor (FBP10), analog/digital Fieldbus Cards (FBCs) and power supply and power monitor card. These Cluster I/O subsystems meet the needs of applications where a high number of channels per card is required. Figure 6 shows a typical twinaxial Fieldbus configuration. Refer to the Fieldbus Cluster I/O Subsystem Product Specification Sheet for additional information.

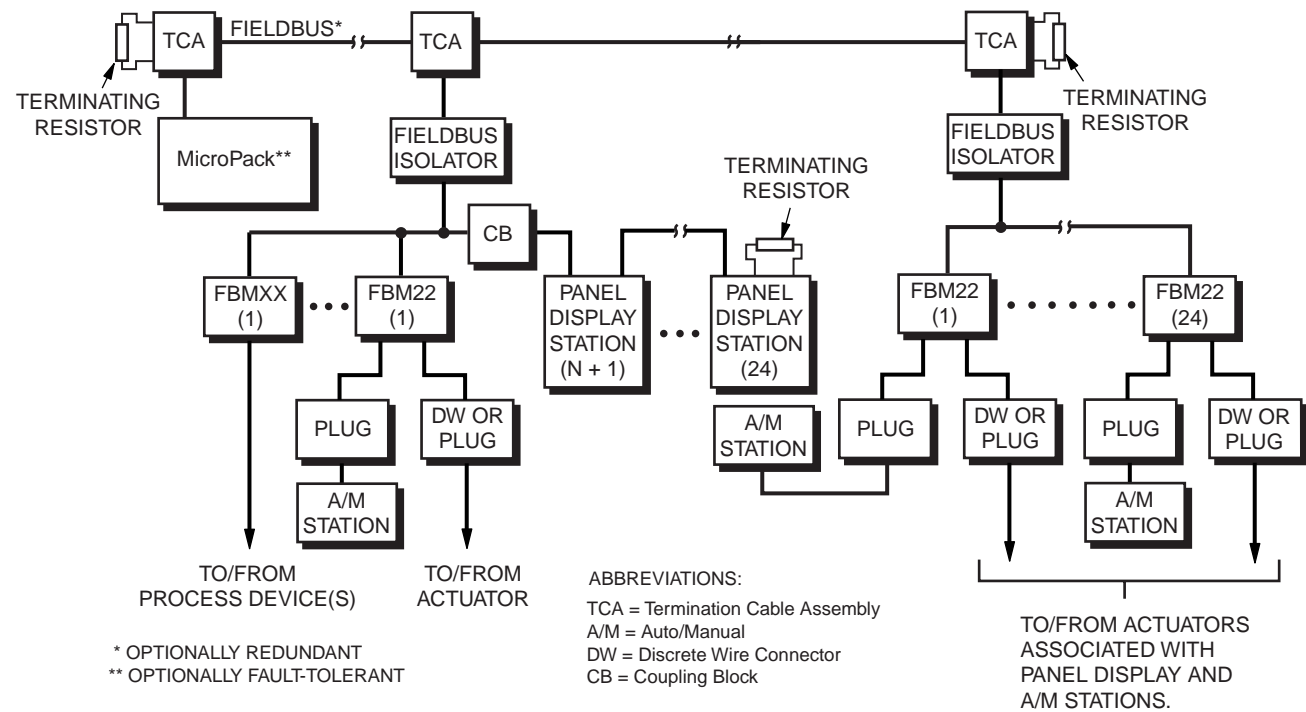


Figure 4. Panel Display Station Interface Configuration using Twinaxial Fieldbus (Typical Configuration)

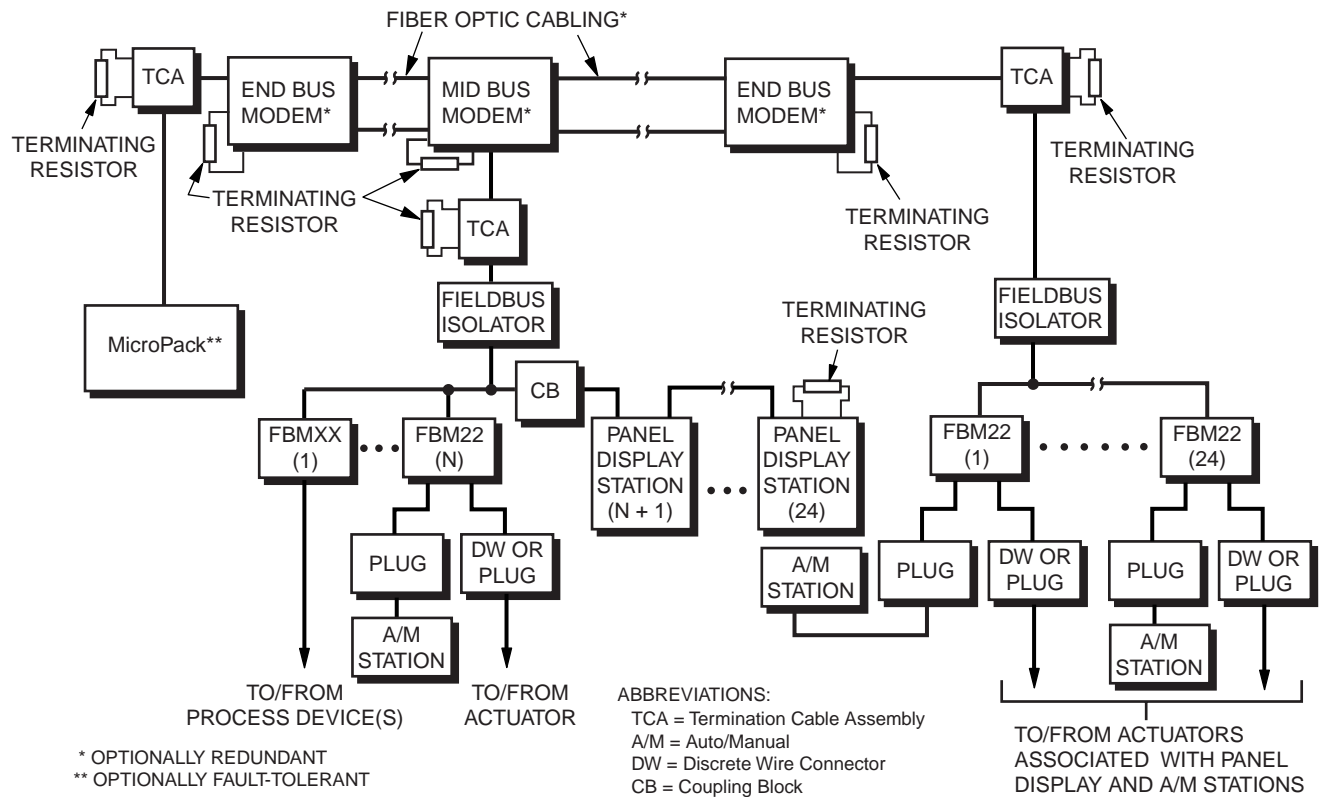


Figure 5. Panel Display Station Interface Configuration using Fiber Optic Fieldbus (Typical Configuration)

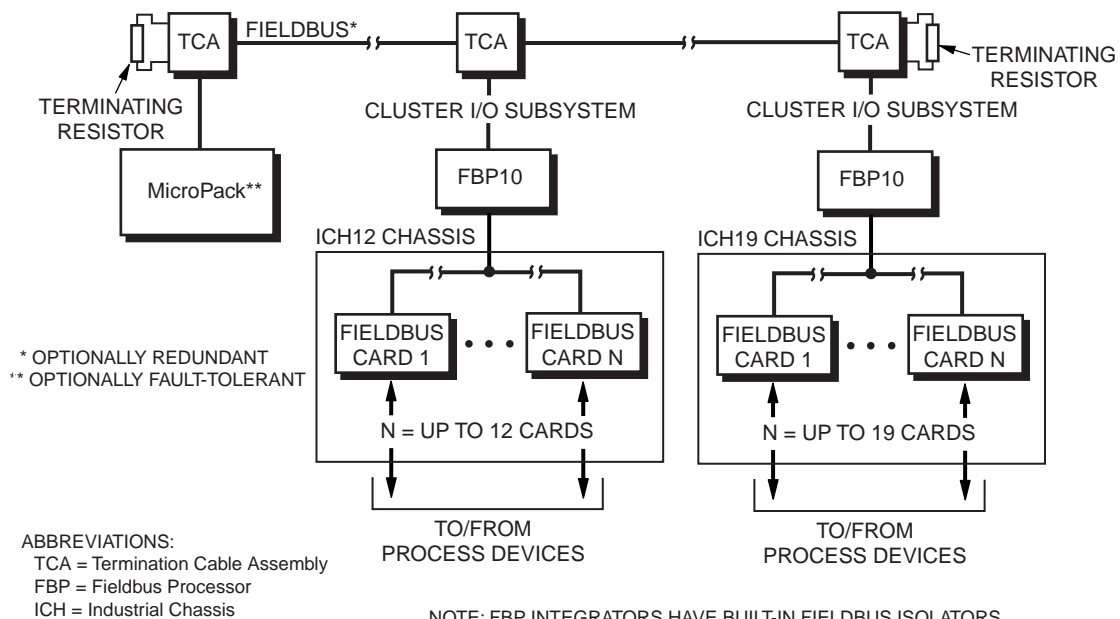


Figure 6. Twinaxial Fieldbus Cluster I/O Subsystem Interface Configuration (Typical Configuration)

**SPECTRUM Migration Interfacing**

The MicroPack Control Processor interfaces with a SPECTRUM Migration Integrator subsystem via a single or redundant I/A Series Fieldbus and a Fieldbus Processor (FBP) with built-in FBP Isolator located within the subsystem. There are four different FBP Integrators to accommodate Unit Control Modules (UCM), Field Input/Output units (FIO), Universal Field Multiplexers (UFM), and Universal Input/Output units (UIO).

The MicroPack control strategy can include any of following SPECTRUM configurations:

- Single SPECTRUM Migration Integrator subsystem
- Multiple types of SPECTRUM Migration Integrator subsystems
- Fieldbus Modules (FBMs) or other Fieldbus-based process interface subsystems along with the SPECTRUM Integrator subsystem(s).

Control is via the software resident in the FBP Integrator and in the SPECTRUM I/O Equipment Control Blocks (ECBs) operating at the CP level. Figure 7 illustrates a typical configuration with multiple types of integrator subsystems with nests of I/O cards. Refer to SPECTRUM Migration Integrators Product Specification Sheet for additional information.

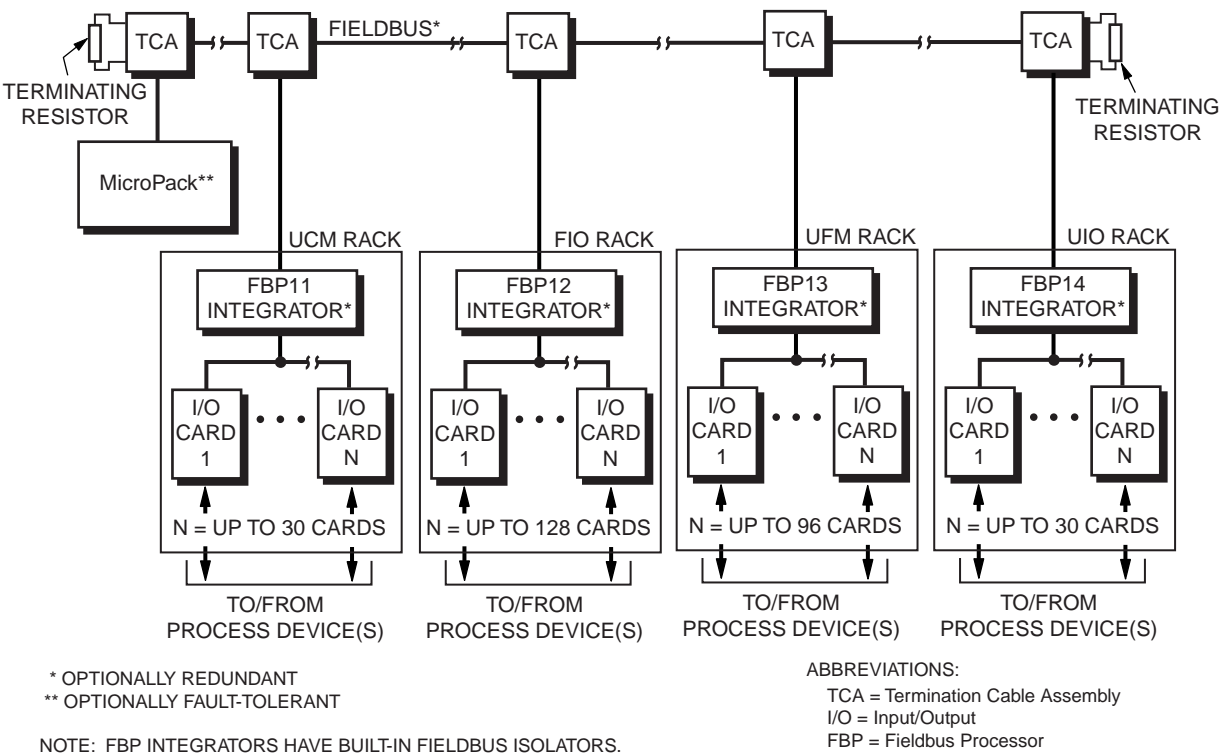


Figure 7. Twinaxial Fieldbus SPECTRUM Migration Subsystem Interface Configuration (Typical Configuration)

### SPEC 200 Control Interfacing

For migration of SPEC 200 control to I/A Series systems, the MicroPack Control Processor interfaces via a single or redundant I/A Series Fieldbus with the SPEC 200 Control Integrator subsystem. This subsystem consists of individual Control Integrators, and Fieldbus Isolators attached within the SPEC 200 rack.

Control is via the software resident in the Control Integrator and in the SPEC 200 I/O Equipment Control Blocks (ECBs) operating at the CP level. Figure 8 illustrates a typical configuration with multiple Control Integrators in the SPEC 200 subsystem. Refer to the SPEC 200 Control Integrators Product Specification Sheet for additional information.

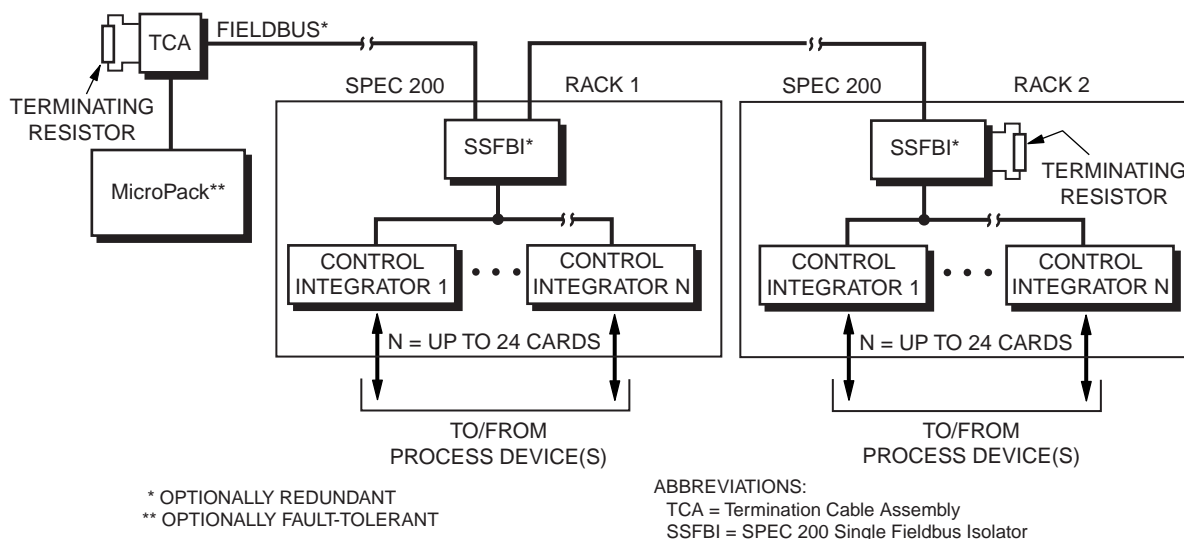


Figure 8. Twinaxial Fieldbus SPEC 200 Control Subsystem Interface Configuration (Typical Configuration)

**SPEC 200 MICRO Control Interfacing**

For migration of SPEC 200 MICRO control to I/A Series systems, the MicroPack Control Processor interfaces via a single or redundant I/A Series Fieldbus with the SPEC 200 MICRO Control Integrator subsystem. This subsystem consists of individual control integrators, and Fieldbus Isolators attached within the SPEC 200 MICRO rack (NCM or SPEC 200 2ANU).

Control is via the software resident in the Control Integrator and in the SPEC 200 MICRO I/O Equipment Control Blocks (ECBs) operating at the CP level. Figure 9 illustrates a typical configuration with multiple Control Integrators in the SPEC 200 MICRO subsystem. Refer to the SPEC 200 MICRO Control Integrators Product Specification Sheet for additional information.

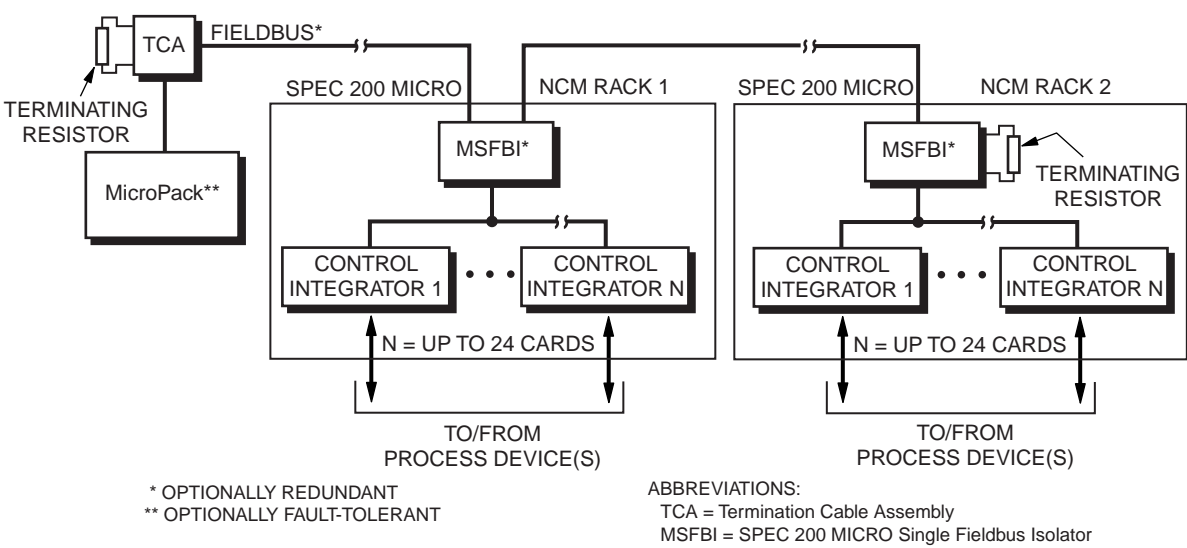


Figure 9.  
Twinaxial Fieldbus SPEC 200 MICRO Control Subsystem Interface Configuration (Typical Configuration)



## FUNCTIONAL SPECIFICATIONS

### Processor Type

Microprocessor-based AMD 486DX5 (running at 133 MHz) with stored programs, using high speed communication capability.

### Memory

#### SIZE

4 MB storage

#### ERROR DETECTION

ECC memory subsystem provides single bit error detection and correction for each byte.

### Process I/O Communications

#### LOCAL TWINAXIAL(a) FIELDBUS

##### Type

EIA RS-485

##### Distance

10 m (30 ft)

##### Transmission Rate

268.75 Kbps

#### EXTENDED TWINAXIAL(a) FIELDBUS(b)

##### Type

EIA RS-485

##### Distance

1800 m (6000 ft)

##### Transmission Rate

268.75 Kbps

#### FIBER OPTIC FIELDBUS(c)

##### Type

Optical

##### Distance

20 km (12.4 mi)

##### Transmission Rate

268.75 Kbps

(a) The twinaxial Fieldbus uses a dual conductor coaxial cable.

(b) Fieldbus Isolator(s) required.

(c) Fiber optic modem(s) required.

(d) Excluding expansion modules.

### Process I/O Capacity

#### LOCAL

24 Fieldbus Modules(d), maximum

#### EXTENDED

64 Fieldbus Modules(d), maximum (24 maximum on any one Fieldbus Isolator)

#### PANEL DISPLAY STATION INTERFACING

Up to 64 FBMs(d) or FBM equivalents (24 maximum on any one Fieldbus Isolator). One Panel Display Station counts as two FBMs. For example, if 24 FBMs are used, only 20 Panel Display Stations may be used.

### Power Requirements

#### INPUT VOLTAGE (REDUNDANT VOLTAGE)

39 V dc typical

#### CONSUMPTION (PER NON-FAULT-TOLERANT MODULE)

15 W, maximum

### Indicators

Red and green light-emitting diodes (LEDs) indicate operational status.

### Internal Diagnostics

Self-checking performed at power-up. Run-time checks and watchdog timer function performed during operation.

**ENVIRONMENTAL SPECIFICATIONS(a)**

**Operating**

**TEMPERATURE**

0 to 60°C (32 to 140°F)

**RELATIVE HUMIDITY**

5 to 95% (Noncondensing)

**ALTITUDE**

-300 to +3,000 m (-1,000 to +10,000 ft)

**Storage**

**TEMPERATURE**

-40 to +70°C (-40 to +158°F)

**RELATIVE HUMIDITY**

5 to 95% (Noncondensing)

**ALTITUDE**

-300 to +12,000 m (-1,000 to +40,000 ft)

**Environmental Contamination Level**

Class G3 (Harsh) as defined in ISA Standard S71.04

(a) The environmental ranges can be extended by the type of enclosure containing the module. Refer to the applicable Product Specification Sheet (PSS) which describes the specific enclosure that is to be used.

**PHYSICAL SPECIFICATIONS**

**Configuration**

Single-width processor module. The fault-tolerant version consists of two single-width processor modules with an interconnecting ZA-bus.

**Mass (Maximum)**

1.2 kg (2.7 lb) for a single, non-fault-tolerant module.

**Mounting**

May be placed in any of the following mounting structure slots:

- 1x8 Mounting Structure
- Industrial Enclosures (IE16 and IE32), Structural Foam or Metal
- Field Enclosure 8, Structural Foam or Metal

In the fault-tolerant version, the two modules must be mounted in adjacent mounting structure slots with an interconnecting ZA-bus.



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